



# Electronic Filing System (EFS) Data

## Electronic Patent Application Submission

### USPTO Use Only

EFS ID: 63521

Application ID: 10749096



Title of Invention:  
MULTI-LAYER INTEGRATED  
SEMICONDUCTOR STRUCTURE  
HAVING AN ELECTRICAL  
SHIELDING PORTION

First Named Inventor: Rafael Reif

Domestic/Foreign Application: Domestic Application

Filing Date: 2003-12-30

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Submission Type:  
Information Disclosure  
Statement

Filing Type:

Confirmation number: 3177

Attorney Docket Number: MIT-136DUS

Total Fees Authorized:

Digital Certificate Holder: cn=Christopher S. Daly,ou=Registered Attorneys,ou=Patent and  
Trademark Office,ou=Department of Commerce,o=U.S. Government,c=US  
Certificate Message Digest: 696de19da1500851bf65218d971d83ffc96d64b0



## TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

Title of Invention	MULTI-LAYER INTEGRATED SEMICONDUCTOR STRUCTURE HAVING AN ELECTRICAL SHIELDING PORTION	
Application Number:	10/749096 	
Date:	2003-12-30	
First Named Applicant:	Rafael Reif	
Confirmation Number:	3177	
Attorney Docket Number:	MIT-136DUS	
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Submitted by:	Elec. Sign.	Sign. Capacity
Christopher S Daly Registered Number: 37,303	/csd/	Attorney
Documents being submitted us-ids	Files MIT-136DUS-usidst.xml us-ids.dtd us-ids.xsl	
Comments		



## ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18  
Stylesheet Version v18.0

Title of Invention	MULTI-LAYER INTEGRATED SEMICONDUCTOR STRUCTURE HAVING AN ELECTRICAL SHIELDING PORTION						
Application Number:	10/749096 						
Confirmation Number:	3177						
First Named Applicant:	Rafael Reif						
Attorney Docket Number:	MIT-136DUS						
Art Unit:	3745						
Search string:	( 4313126 or 4402761 or 4456888 or 4599704 or 4986861 or 5156997 or 5206186 or 5445994 or 5821138 or 5923087 or 6441478 ).pn.						
<b>US Patent Documents</b>							
Note: Applicant is not required to submit a paper copy of cited US Patent Documents							
init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
	1	4313126	1982-01-26	Krumm et al.			
	2	4402761	1983-09-06	Feist			
	3	4456888	1984-01-26	Ayasli			
	4	4599704	1986-07-08	Mazin			
	5	4986861	1991-01-22	Nishida et al.			
	6	5156997	1992-10-20	Kumar et al.			
	7	5206186	1993-04-27	Neugebauer et al.			
	8	5445994	1995-08-29	Gilton			
	9	5821138	1998-10-13	Yamazaki et al.			
	10	5923087	1999-07-13	Suzuki et al.			
	11	6441478	2002-08-27	Park			
<b>Signature</b>							
Examiner Name				Date			